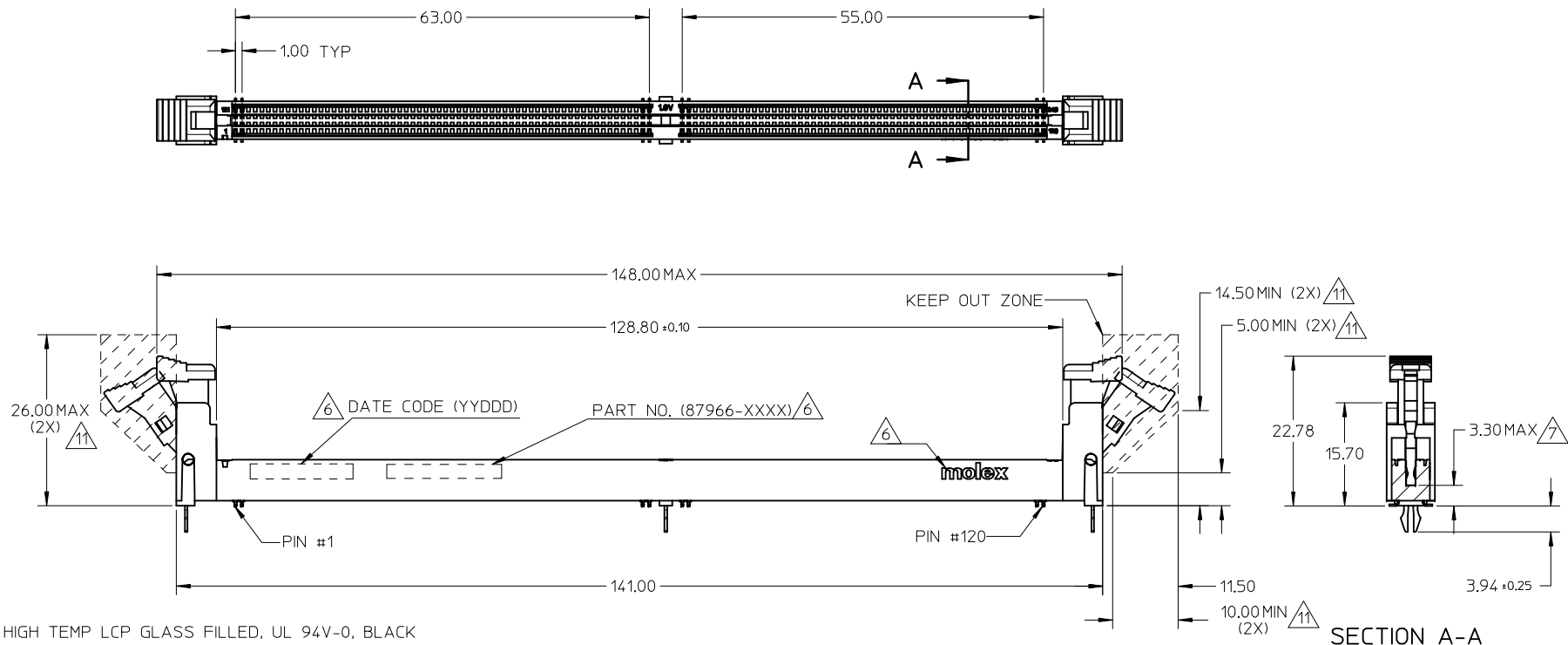




NOTES:

- MATERIALS
HOUSING - HIGH TEMP LCP GLASS FILLED, UL 94V-0, BLACK
EJECTORS - HIGH TEMP NYLON GLASS FILLED, UL 94V-0, BLACK
TERMINALS - COPPER ALLOY
- PLATING OPTION - PLS REFER TO SHEET 5.
- CARD SLOT ACCEPTS 1.27±0.10MM MODULE THICKNESS. (MEASURED OVER PC PADS)
- RECOMMENDED MODULE LAYOUT SHALL BE AS PER JEDEC MO-237. PLS REFER TO SHEET 3.
- PRODUCT IS PACKED INTO TRAYS. WRAP IN MOISTURE BARRIER BAG WITH SILICA GEL.
- MOLEX LOGO, DATE CODE & PART NO. INDICATED ON HOUSING.
- DIMM MODULE SEATING PLANE FROM TOP OF PCB.
- COPLANARITY FOR SOLDERTAILS SHALL NOT EXCEED 0.20MM.
- REFER TO PRODUCT SPEC. PS-87966-001 FOR PERFORMANCE SPECIFICATIONS.
- THE KEEP OUT AREA IS THE AREA WHERE THE CONNECTOR IS MOUNTED ONTO THE PCB, WHICH DOES NOT INCLUDE THE LATCH.
- KEEP OUT ZONE AS PER JEDEC S0-001.
- CONTACT MOLEX FOR AVAILABILITY OF PRODUCT OPTIONS.

ADDED MBB & S.GEL EC NO: S2012-0451 2012/12/07 DRWN:CCTEH CHK:DEKSOH 2013/01/03 APPR:SHLENI			QUALITY SYMBOLS 	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm INCH		DRAWN BY DATE		TITLE DDR2 DIMM, 1.00MM PITCH 240 CKTS, SMT					
				4 PLACES ± --- ± ---		CCTEH 2005/10/19							
				3 PLACES ± --- ± ---		CHECKED BY DATE		molex					
				2 PLACES ± 0.10 ± ---		SRRAMESH 2005/11/21							
				1 PLACE ± --- ± ---		APPROVED BY DATE							
0 PLACE ± ±		GGLEE 2005/11/21		DOCUMENT NO. SD-87966-002									
ANGULAR ± 1 °		MATERIAL NO.								SHEET NO. 1 OF 5			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE											
B2		REV		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

10 9 8 7 6 5 4 3 2 1

F F

E E

D D

C C

B B

A A

7.35

33.10 REF

1.55 REF

3.10 REF

tb_frame_A3_P_AM_T
Rev. G 2012/01/11

9 8 7 6 5 4 3 2 1

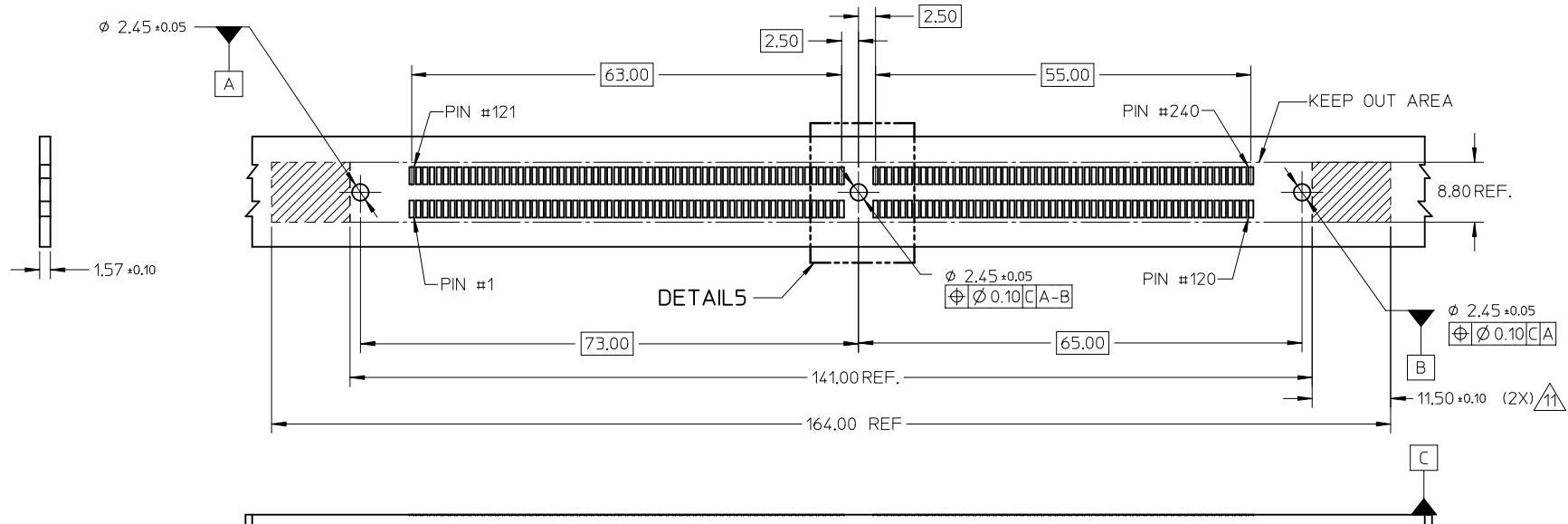
ADDED MBB & S.GEL EC NO: S2012-0451 DRWN:CCTEH 2012/12/07 CHKD:EKSOH 2013/01/03 APPR:SHLENI 2013/01/03 B2	REV	DESCRIPTION	QUALITY SYMBOLS ▽_F=0 ▽_E=0 ▽_B=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	TITLE DDR2 DIMM, 100MM PITCH 240 CKTS, SMT		
					mm	INCH	DRAWN BY CCTEH	DATE 2005/10/19	molex				
				4 PLACES	± ---	± ---	CHECKED BY SRRAMESH	DATE 2005/11/21					
				3 PLACES	± ---	± ---	APPROVED BY GGLEE	DATE 2005/11/21	SD-87966-002				
				2 PLACES	± 0.10	± ---	MATERIAL NO.					DOCUMENT NO.	
				1 PLACE	± ---	± ---	SEE TABLE		INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
				0 PLACE	±	±							
				ANGULAR ± 1 °									
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS									

10	9	8	7	6	5	4	3	2	1
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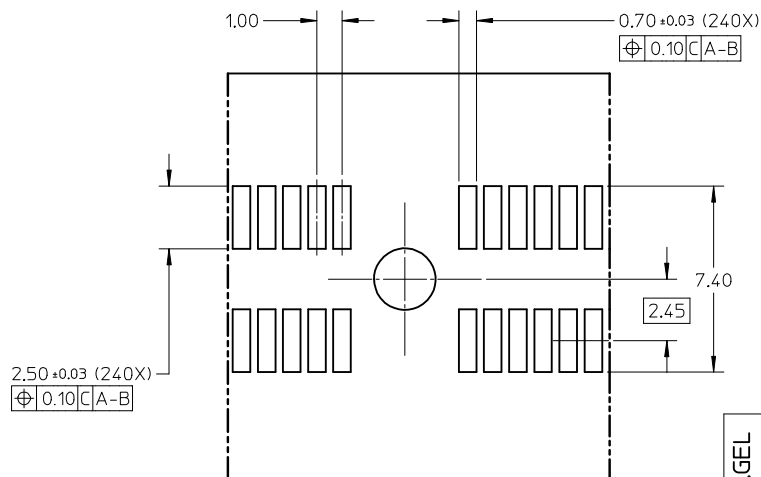


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RECOMMENDED STENCIL THICKNESS = 150 μ M.



DETAIL5

ADDED MBB & S.GEL EC NO: S2012-0451 DRWN: CCTEH 2012/12/07 CHK: DEKSOH 2013/01/03 APPR: SHLENI 2013/01/03	DESCRIPTION REV	QUALITY SYMBOLS
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